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10748523 - GAJ-1,02436) Approved for use through 07/31/2012. OMB 0651-0031 U.S. Patent and Trademark Office; U.S. DEPARTMENT OF COMMERCE

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Application Number		10748523				
Filing Date		2003-12-30				
First Named Inventor	Micha	uel Chiviendacz				
Art Unit		2436				
Examiner Name	Fikrer	nariam A. Yalew				
Attorney Docket Number		10500.03.0716				

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